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Washington, D.C. 20231



Enclosed for filing is the patent application of
Inventor(s): **KANADE**

**FOR: METHOD AND SYSTEM FOR ALLOCATION OF SPECIAL PURPOSE COMPUTING RESOURCES
IN A MULTIPROCESSOR SYSTEM**

ALSO ENCLOSED ARE

- [X] 7 sheets of drawings.
- [X] An assignment to **CODITO TECHNOLOGIES PRIVATE LIMITED**
- [X] A fully executed declaration.
- [X] Non Publication Request
- [] Preliminary Amendment.
- [X] Information Disclosure Form PTO-1449.

FEE COMPUTATION

CLAIMS AS FILED				
FOR	Number Filed	Number Extra	Rate	Basic Fee - \$375.00
Total Claims	18	0	x \$9 =	0
Independent Claims	3	0	x \$42 =	0
Assignment Recordation Fee			\$ 40 =	40
TOTAL FILING FEE				\$ 415.00

The undersigned (Reg. No. 27,990) authorizes the Commissioner to charge any fees under 37 CFR 1.16 and 1.17 which may be required by this paper to Deposit Account No. 502158. A duplicate copy of this paper is enclosed.

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CERTIFICATE OF MAILING

- [X] Express Mail Mailing Label No. **EU910991432US**
Date of Deposit **September 22, 2003**

I hereby certify that this paper and fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner for Patents, PO. Box 1450, Alexandria, Virginia 22313-1450

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Signature _____

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PTO/SB/35 (11-00)

Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U. S. DEPARTMENT OF COMMERCE

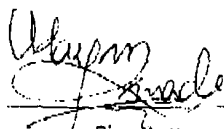
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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)	First Named Inventor		Kanade
	Title	Method... Multiprocessor System	
	Atty Docket Number		COT-003

I hereby certify that the invention disclosed in the attached application **has not and will not** be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

18 September 2003
Date


Signature

UDAYAN KANADE
Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(e). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Asistant Commissioner for Patents, Washington, DC 20231.